

SAMSUNG TFT-LCD

# MODEL: LSF460HN02-A

Samsung Display Co., LTD

MODEL LSF460HN02-A	Doc. No		Page	1 / 42
--------------------	---------	--	------	--------



## SAMSUNG Confidential

## **Contents**

Revision History(3)
General Description(4)
General Information(4)
1. Absolute Maximum Ratings(5)
2. Optical Characteristics(6)
3. Electrical Characteristics(11)
3.1 TFT LCD Module
4. Block Diagram(12)
5. Input Terminal Pin Assignment(13)
5.1 Input Signal & Power
5.2 LVDS Interface
5.3 Input Signals, Basic Display Colors and Gray Scale of Each Color
6. Interface
6.1 Timing Parameters (DE only mode)
6.2 Characteristics of LVDS Input data
6.3 Timing Diagrams of interface Signal (DE only mode)
6.4 Power ON/OFF Sequence
7. Outline Dimension(23)
7.1 The adhesive size of POL
7.2 The drawing sheet for the size of the OLB bonding
7.4 Cross Section of cell
7.5 Source PCB
7.6 FFC cable
7.7 Control PCB
8. Reliability Test
9. General Precaution(25)
9.1 Handling
9.2 Storage
9.3 Operation
9.4 Guide for the Operation Condition
9.5 Others
10. Special Precautions(29)
11. Example
Appendix1
Appendix2

MODEL	LSF460HN02-A	Doc. No		Page	2 / 42
-------	--------------	---------	--	------	--------



SAMSUNG Confidential

## The revision history

Date	Rev. No	Page	Summary
19.Nov.2012	000	all	First Issue (First Draft)
28.Nov.2012	001	P.4 P.33	Change the tolerance of Panel size, the Panel mode
29.Nov.2012	002	P.29 P.13, 14 P.25	Change storage condition for packing Change Input signal& power Add drawing sheet for the size of the OLB bonding
07.Dec.2012	003	P.6	Change Gdiff. And Wx uni, Wy uni. spec
11.Dec.2012	004	P.4 P.13	Change Glass size tolerance, weight Delete LVDS_SEL(Pin 45)
12.Dec.2012	005	P.5 P.6	Change Max Humidity for storage,Operating humidity Change Gdiff, C/R min

MODEL LSF460HN02	A Doc. No	Page 3 / 42
------------------	-----------	-------------

SAMSUNG Confidential

## **General Description**

#### Description

This model uses a liquid crystal display (LCD) of amorphous silicon TFT as switching components. This model is composed of a TFT LCD panel, a driver circuit, and an ass'y KIT of source PBA. This 46.0" model has a resolution of a 1920 x 1080 and can display up to 16.7 million colors with the wide viewing angle of 89° or a higher degree in all directions. This panel is designed to support applications by providing a excellent performance function of the flat panel display such as home-alone multimedia TFT-LCD TV and a high definition TV.

#### **General Information**

#### Features

- RoHS compliance (Pb-free)
- High contrast ratio & aperture ratio with the wide color gamut
- SVA(Super Vertical align) mode
- Wide viewing angle (±178°)
- High speed response
- FHD resolution (16:9)
- Low power consumption
- DE (Data enable) mode
- The interface (2pixel/clock) of 1ch LVDS (Low voltage differential signaling)

Items	Specification	Unit	Note
Active Display Area	1018.08(H) x 572.67(V)	mm	
Switching Components	a-Si TFT Active matrix		
Glass Size	TFT : 1036.08(H) x 591.4(V) CF : 1030.88(H) x 588.7(V)	mm	±0.4mm
Panel Size	1036.08(H) x 591.4(V)	mm	±0.4mm
	1.80(D)	mm	±0.1mm
Weight	2,500	g	
Display Colors	16.7M (True Display) 1.07B (Dithered 10bit)	color	
Number of Pixels	1,920 × 1,080	pixel	16 : 9
Pixel Arrangement	RGB Vertical Stripe		
Display Mode	Normally Black		
Surface Treatment	AG-POL(Anti Glare),		
Haze	2.3 %		±2.1%
Hardness	2H		

MODEL	LSF460HN02-A	Doc. No		Page	4 / 42
-------	--------------	---------	--	------	--------

## 1. Absolute Maximum Ratings

If the figures on measuring instruments exceed maximum ratings, it can cause the malfunction or the unrecoverable damage on the device.

Item	Symbol	Min.	Max.	Unit	Note
Power supply voltage	$V_{DD}$	10.8	13.2	V	(1)
Temperature for storage	T <sub>STG</sub>	-20	65	°C	(2),(4)
Temperature of glass surface	T <sub>OPR2</sub>	0	65	°C	(2)
Operating temperature	T <sub>OPR</sub>	0	50	°C	(2),(5)
Humidity for storage	H <sub>STG</sub>	5	95	%RH	(2),(4)
Operating humidity	H <sub>STG</sub>	20	95	%RG	(2),(5)
Endurance on static electricity			150	V	(3)

Note (1) The power supply voltage at Ta= 25  $\pm$  2 °C

- (2) Temperature and the range of relative humidity are shown in the figure below.
  - a. 90 % RH Max. (Ta ≤ 39 °C)
  - b. The relative humidity is 90% or less. (Ta > 39 °C)
  - c. No condensation
  - d. Operating condition with SET
- (3) Keep the static electricity under 150V in Polarizer attaching process.
- (4) Operating condition with source PCB
- (5) Storage temperature condition including glass
- (6) Condition without packing. (Unpacking condition)

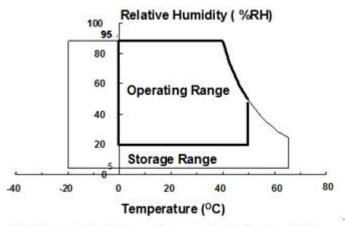


Fig. Range for temperature and relative humidity.

#### 2. Optical characteristics

The optical characteristics should be measured in the dark room or the space surrounded by the similar setting.

Measuring equipment : TOPCON RD-80S, TOPCON SR-3 , ELDIM EZ-Contrast

(Ta = 25 ± 2°C, VDD=12.0V, fv=60Hz, f<sub>DCLK</sub>=148.5MHz, Light source: D65 Standard light)

Iter		Symbol	, tv=60Hz, t <sub>DCL</sub> Condition	Min.	Тур.	Max.	Unit	Light Source	Note
Contras (At the cente		C/R		-	5,000	-		Standard	(1) SR-3
Response time	G-to-G	Tg	T <sub>PAN,SUR</sub> =29.9℃	-	8	16	msec	Standard or VD BLU	(3) RD-80S
Luminance (At the cente		YL		TBD	TBD	-	cd/m <sup>2</sup>	VD BLU	(4) SR-3
Red	Red	Rx			0.640				
	Ry	Normal		0.330					
	Green	Gx	qL,R=0 qU,D=0 Viewing		0.300				
Chromaticity	Green	Gy		TYP. -0.03	0.600	TYP. +0.03		VD BLU	(5),(6) SR-3
(CIE 1931)	Blue	Bx	Angle	-0.03	0.150	+0.03			5K-3
	Dide	By			0.060				
	White	Wx			0.280				
	VVIIIto	Wy			0.290				
sRGB Con	cordance	-			99		%		
Color g	jamut	-		-	72	-	%	VD BLU	(5) SR-3
Col	or	-		7,000	10,000	-	К		
	Hor.	q <sub>L</sub>	- C/R≥10	75	89	-	- Degree		
Viewing		9 <sub>R</sub>		75	89	-		Standard or	(6) SR-3
Angle	Ver.	q <sub>U</sub>		75	89	-		VD BLU	EZ-Contrast
		α <sub>D</sub>		75	89	-			
Brightness (9 Po		B <sub>uni</sub>		-	-	TBD	%	Standard	(2) SR-3
Transmi	issivity	Т		5.49	5.90	-	%	Standard	(7) D65/SR3
Transmissivit	y Uniformity	T <sub>uni</sub>		-	-	10	%	Standard	(8) D65/SR3
Gamma	Value	GMA		2.0	2.2	2.4		Standard or	(9) SR-3
Gamma v	variation	Gdiff	(@20G~128G)	-0.14	-	0.14		VD BLU	(11) SR-3
ACC Lir	nearity	ACC_lin		-0.015	0.0	0.015		Standard or VD BLU	(12) SR-3
5nit Unit	formity	Buni_5nit		-30	0.0	30	%	Standard (38G/255G)	(10) SR-3
White Color	Coordinate	Wx uni		-		0.005		Otara la sel	(13)
Unifor		Wy uni				0.008		Standard	SR-3
MODEL	LSF	460HN02	-A Doc.	No				Page	6 / 42

#### SAMSUNG Confidential

#### Notice

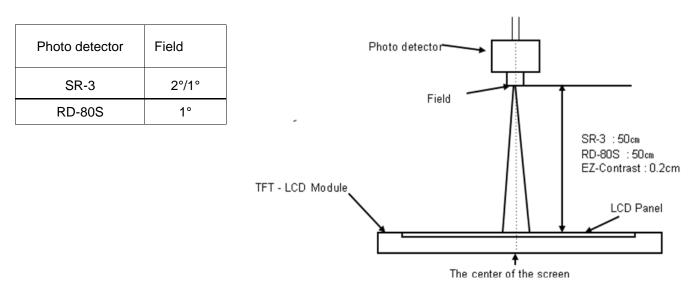
#### (a) Setup for test equipment

The measurement should be executed in a stable, windless, and dark room for 40min and 60min after operating the panel at the given temperature for stabilization of the standard light. (SDC uses the standard luminance of the D65 media).

This measurement should be measured at the center of screen.

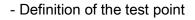
- The environment condition: Ta =  $25 \pm 2$  °C
- (b) D65 media has the general light source.

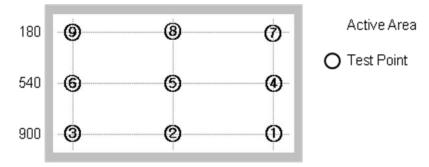
The temperature of color is 6847K. The coordinate of color is Wx 0.313, Wy 0.329 The luminance of this product is 7217 cd/m<sup>2</sup>.



(c) The CIE positions D65 as the standard daylight illuminant:

[D65] is intended to represent average daylight and has a correlated color temperature of approximately 6500 K. CIE standard illuminant D65 should be used in all colorimetric calculations requiring representative daylight, unless there are specific reasons for using a different illuminant.





Note (1) Definition of contrast ratio (C/R)

: The ratio of gray max (Gmax) & gray min (Gmin) at the center point ⑤ of the panel The measurement goes in D65 Standard light source

$$C/R = \frac{G \max}{G \min}$$
  
Gmax : The luminance with all white pixels



#### SAMSUNG DISPLAY

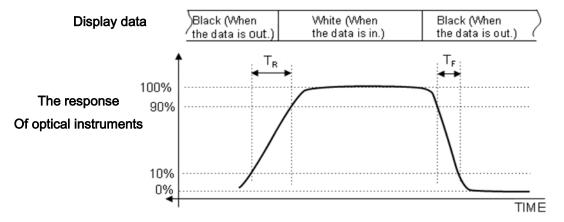
Gmin : The luminance with all black pixels

Note (2) Definition of the brightness uniformity of 9 points (Test pattern : The full white) The measurement shall be executed with the standard light source of D65.

 $Buni = 100*\frac{(B\max - B\min)}{B\max}$ 

Bmax : The maximum brightness Bmin : The minimum brightness

Note (3) Definition of the response time : Sum of Tr, Tf



※ G-to-G : Average response time between whole gray scale to whole gray scale.

The response time is the value that was measured after it was operated in Samsung's standard BLU for one hour.( at room temperature)

Note (4) The definition of luminance of white: The luminance of white at the center point (5) The measurement shall be executed with the standard light source of D65.

Note (5) The definition of chromaticity (CIE 1931)

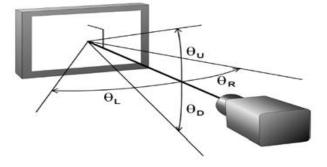
The color coordinate of red, green, blue and white at the center point (5)

The measurement shall be executed with the standard light source of D65.

Note (6) Definition of viewing angle

: The range of viewing angle (C/R  $\geq$ 10)

The measurement shall be executed with the standard light source of D65.



MODEL	LSF460HN02-A	Doc. No		Page	8 / 42
-------	--------------	---------	--	------	--------

Note (7) Definition of transmissivity

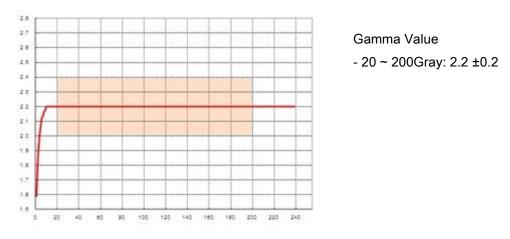
The measurement shall be executed with the standard light source of D65.

Note (8) Definition of the Transmissivity uniformity of 9 points (Test pattern: The full white) The measurement shall be executed with the standard light source of D65.

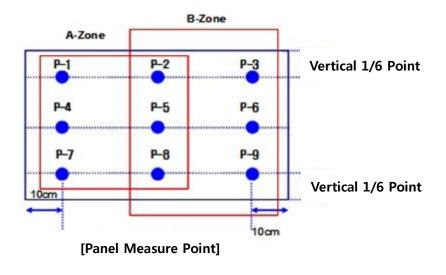
$$Tuni = 100^* \frac{(Tmax - Tmin)}{Tmax}$$

Tmax : The maximum Transmissivity Tmin : The minimum Transmissivity

Note (9) Management Criteria of Gamma Value



Note (10) 5nit Low Gray Uniformity



$$Buni_5nit = 100^* \frac{(Bmax_5nit - Bmin_5nit)}{Bmax_5nit}$$

Bmax\_5nit : The maximum brightness at 5nit Gray Bmin\_5nit : The minimum brightness at 5nit Gray

MODEL	LSF460HN02-A	Doc. No		Page	9 / 42
-------	--------------	---------	--	------	--------



Note (11) Gamma Variation between Center and Left (or Right)

Gamma measured at 10cm point from the left & right side is more less than 0.14 than Gamma measured at Center

(Gamma measured at 10cm of the P-4 & P-6 is more less than 0.1 than Gamma measured at P-5)

Note (12) Management Criteria of ACC Linearity

30						
29	F					
27	1					_
26			 	 		
25					 -Wx	
25 24 23					 -Wx -Wy	- 2
24					 	

**255Gray Wx/Wy value basis (a module unit basis)** a. Color coordinate differences are less than 15/1,000 at Any Point above 30Gray and 255Gray

b. When Wx/Wy coordinates reverse at 0Gray, it permits an once intersection under, 30Gray

Note (13) White Color Coordinate Uniformity of 9 points (Test pattern: The full white)

*Wx, uni* = Wx max-Wx min

Wx max : The maximum Wx Wx min : The minimum Wx

*Wy, uni* = Wy max-Wy min

Wy max: The maximum Wy Wy min: The minimum Wy

MODEL	LSF460HN02-A	Doc. No		Page	10 / 42
-------	--------------	---------	--	------	---------

## 3. Electrical characteristics - Sony Model Attached Reference file

#### 3.1 TFT LCD Module

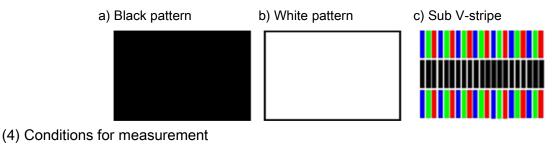
The connector for the display data & timing signal should be connected.

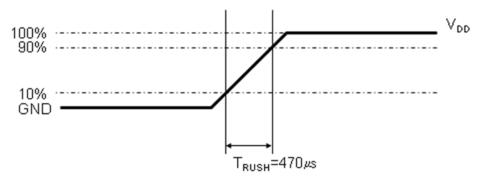
					Ta÷	= 25°C ±	2 °C
	ltem	Symbol	Min.	Тур.	Max.	Unit	Note
Voltage	e of power supply	V <sub>DD</sub>	10.8	12.0	13.2	13.2 V	
	(a) Black		-	500	700	mA	
Current of power supply	(b) White	l <sub>DD</sub>	-	500	750	mA	(2),(3)
Supply	(c) Sub V-Stripe		-	800	1100	mA	
Vsy	nc frequency	$f_v$	48	60	66	Hz	
Hsy	vnc frequency	f <sub>H</sub>	54	67.5	74.25	kHz	
Ма	in frequency	Fdclk	118.8	148.5	163.35	MHz	
R	ush current	I <sub>RUSH</sub>	-	-	2	А	(4)

Note (1) The ripple voltage should be controlled fewer than 10% of  $V_{DD}$  (Typ.) voltage.

(2) fV=60Hz, fDCLK =148.5MHz,  $V_{DD}$  = 12.0V, DC Current.

(3) Power dissipation check pattern (LCD Module only)



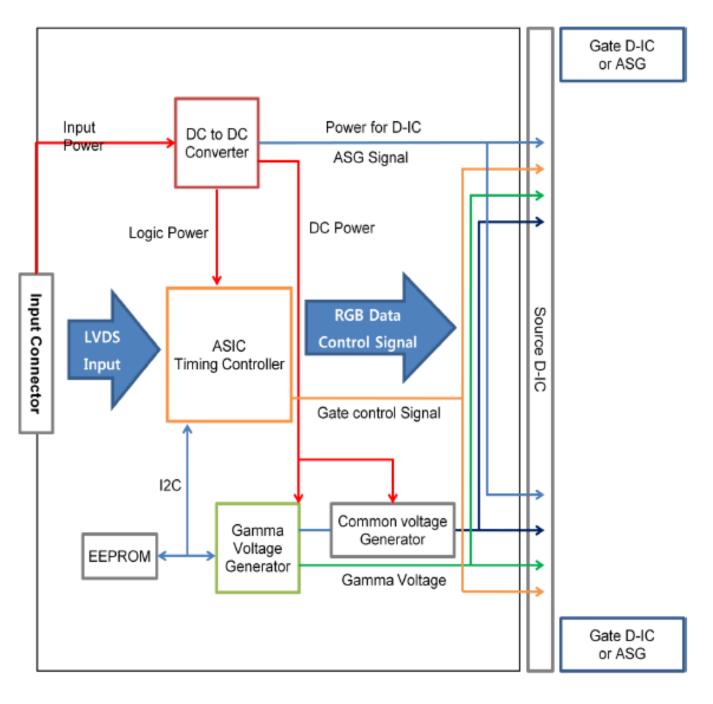


The rush current,  $I_{RUSH}$  can be measured during  $T_{RUSH}$  is 470us

MODEL	LSF460HN02-A	Doc. No	Page	11 / 42



## 4. Block diagram



MODEL	LSF460HN02-A	Doc. No		Page	12 / 42
-------	--------------	---------	--	------	---------

## 5. The Pin assignment in the input terminal

5.1. Input signal & power

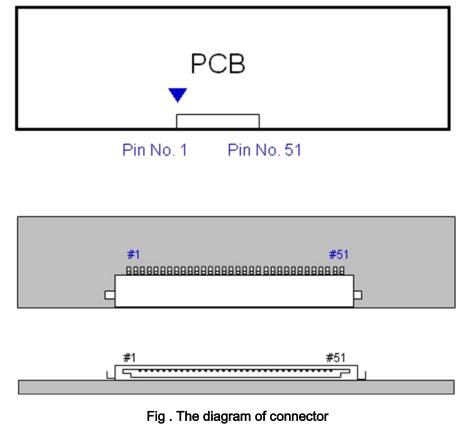
```
Connector : FI-RE51S-HF (JAE/UJU)
```

				Connoctor		, ,			
Pin	D	escription	Pin		Description				
1	١	/dd (12V)	26		RE[0]	Р			
2	۱	/dd (12V)	27		RE[1]	N			
3	۱	/dd (12V)	28		RE[1]	Ρ			
4	\	/dd (12V)	29		N				
5	١	/dd (12V)	30		Р				
6	No	connection	31	Even	)				
7		GND	32	LVDS	Even				
8		GND	33	Signal	RECL	۲+			
9		GND	34		GND	)			
10		RO[0]N	35		RE[3]	N			
11		RO[0]P	36		RE[3]	Р			
12		RO[1]N	37		RE[4]	N			
13		RO[1]P	38		RE[4]	Р			
14		RO[2]N	39		GND				
15		RO[2]P	40	No cor	nection				
16	Odd	GND	41	No cor	nection				
17	LVDS Signal	ROCLK-	42	No cor	nection				
18	0.9	ROCLK+	43	No cor	nection				
19		GND	44	No cor	nection				
20		RO[3]N	45	No cor	nection	NOTE1			
21		RO[3]P	46	No cor	nection				
22		RO[4]N	47	No cor	nection				
23		RO[4]P	48	No cor	nection				
24		GND	49	No cor	nection				
25	Even LVDS	RE[0]N	50	No cor	nection				
			51	Agir	ng EN	NOTE2			

MODEL	LSF460HN02-A	Doc. No	Page	13 / 42



Note (1) Pin number which starts from the left side.



a. Power GND pins should be connected to the LCD's metal chassis.

b. All power input pins should be connected together.

c. All NC pins should be separated from other signal or power.

Note(3) Aging Enable PIN / IF this Pin GND  $\rightarrow$  BIST MODE (Rolling Pattern is operated)

MODEL LSF460HN02-A	Doc. No		Page	14 / 42
--------------------	---------	--	------	---------

5.2 LVDS Interface

#### - LVDS receiver : T-con (merged) ( 8Bit)

- Data format

	LVDS pin	JEIDA -DATA	Normal-DATA
	TxIN/RxOUT0	R2	R0
_	TxIN/RxOUT1	R3	R1
_	TxIN/RxOUT2	R4	R2
TxOUT/RxIN0	TxIN/RxOUT3	R5	R3
-	TxIN/RxOUT4	R6	R4
-	TxIN/RxOUT6	R7	R5
-	TxIN/RxOUT7	G2	G0
	TxIN/RxOUT8	G3	G1
-	TxIN/RxOUT9	G4	G2
-	TxIN/RxOUT12	G5	G3
TxOUT/RxIN1	TxIN/RxOUT13	G6	G4
-	TxIN/RxOUT14	G7	G5
-	TxIN/RxOUT15	B2	B0
-	TxIN/RxOUT18	B3	B1
	TxIN/RxOUT19	B4	B2
	TxIN/RxOUT20	В5	B3
	TxIN/RxOUT21	B6	B4
TxOUT/RxIN2	TxIN/RxOUT22	В7	B5
-	TxIN/RxOUT24	HSYNC	HSYNC
-	TxIN/RxOUT25	VSYNC	VSYNC
-	TxIN/RxOUT26	DEN	DE
	TxIN/RxOUT27	R0	R6
-	TxIN/RxOUT5	R1	R7
	TxIN/RxOUT10	G0	G6
TxOUT/RxIN3	TxIN/RxOUT11	G1	G7
	TxIN/RxOUT16	B0	B6
	TxIN/RxOUT17	B1	B7
	TxIN/RxOUT23	RESERVED	RESERVED

MODEL LSF460HN02	A Doc. No	Page 15 / 42
------------------	-----------	--------------

## SAMSUNG DISPLAY

SAMSUNG

## SAMSUNG Confidential

#### 5.3 Input signals, basic display colors and the gray scale of each color. (8bit))

					-							D	ATA	SIGN	IAL				-							GRAY
COLOR	DISPLAY (8bit)				R	ED							GRI	EEN							Bl	LUE				SCALE LEVEL
		R0	R1	R2	R3	R4	R5	R6	R7	G0	G1	G2	G3	G4	G5	G6	G7	B0	B1	B2	B3	B4	B5	B6	B7	LEVEL
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	-
	BLUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	-
	GREEN	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	-
BASIC COLOR	CYAN	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	-
	RED	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	-
	MAGENTA	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	-
	YELLOW	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	-
	WHITE	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	-
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R0
		1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R1
CDAY	DARK	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R2
GRAY SCALE	Ť	:	:	:	:	•••	••			:	• •	:	:	•••	••			:	•••	:	:	:	:			R3~
OF RED	Ļ	:	:	:	:	•••	••			:	• •	:	:	•••	••			:	•••	:	:	:	:			R252
	LIGHT	1	0	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R253
		0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R254
	RED	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R255
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	G0
		0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	G1
	DARK	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	G2
GRAY SCALE	Ť	:	:	:	:	:	:			:	:	:	:	:	:			:	:	:	:	:	:			G3~
OF GREEN	Ļ	:	:	:	:	:	:			:	:	:	:	:	:			:	:	:	:	:	:			G252
ORLEN	LIGHT	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1	1	0	0	0	0	0	0	0	0	G253
		0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	G254
	GREEN	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	G255
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	B0
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	B1
	DARK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	B2
GRAY SCALE	Ť	:	:	•	•	:	•			:	•	:	:	•	:			:	•	•	•	:	:			B3~
OF	Ļ	:	:	•	•	:	•			:	•	:	:	•	:			:	•	•	•	:	:			B252
BLUE	LIGHT	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1	1	B253
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	B254
	BLUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	B255
Note)	The definiti	on	of a	rav	•																					

Note) The definition of gray :

Rn : Red gray, Gn : Green gray, Bn : Blue gray (n = Gray level) Input signal : 0 = Low level voltage, 1 = High level voltage

MODEL L	LSF460HN02-A	Doc. No		Page	16 / 42
---------	--------------	---------	--	------	---------



#### SAMSUNG Confidential

#### 5.4 LVDS receiver : T-con (merged) (10Bit)

#### - Data format

	LVDS pin		JEIDA -DATA	Ν	lormal -DATA
	TxIN/RxOUT0		R2		R0
	TxIN/RxOUT1		R3		R1
	TxIN/RxOUT2		R4		R2
TxOUT/RxIN0	TxIN/RxOUT3		R5		R3
	TxIN/RxOUT4		R6		R4
	TxIN/RxOUT6		R7		R5
	TxIN/RxOUT7		G2		G0
	TxIN/RxOUT8		G3		G1
	TxIN/RxOUT9		G4		G2
	TxIN/RxOUT12		G5		G3
TxOUT/RxIN1	TxIN/RxOUT13		G6		G4
	TxIN/RxOUT14		G7		G5
	TxIN/RxOUT15		B2		B0
	TxIN/RxOUT18		B3		B1
	TxIN/RxOUT19		B4		B2
	TxIN/RxOUT20		B5		B3
	TxIN/RxOUT21		B6		B4
TxOUT/RxIN2	TxIN/RxOUT22		B7		B5
	TxIN/RxOUT24		HSYNC		HSYNC
	TxIN/RxOUT25		VSYNC		VSYNC
	TxIN/RxOUT26		DEN		DE
	TxIN/RxOUT27		R0		R6
	TxIN/RxOUT5		R1		R7
	TxIN/RxOUT10		G0		G6
TxOUT/RxIN3	TxIN/RxOUT11		G1		G7
	TxIN/RxOUT16		B0		B6
	TxIN/RxOUT17		B1		B7
	TxIN/RxOUT23		RESERVED		RESERVED
	TxIN/RxOUT28		R0		R8
	TxIN/RxOUT29		R1		R9
	TxIN/RxOUT30		G0		G8
TxOUT/RxIN4(dithered10 it)	TxIN/RxOUT31		G1		G9
	TxIN/RxOUT32		B0		B8
	TxIN/RxOUT33		B1		B9
	TxIN/RxOUT34		RESERVED		RESERVED
MODEL	LSF460HN02-A	Doc. No		Page	17 / 42

## SAMSUNG Confidential

## 5.5 Input signals, basic display colors and the gray scale of each color. (10bit)

															DA	TA S	SIGN	NAL														GRAY
COLOR	DISPLAY					R	ED									GRE	EEN									BL	UE					SCALE
		R0	R1	R2	R3	R4	R5	R6	R7	R8	R9	G0	G1	G2	G3	G4	G5	G6	G7	G8	G9	B0	B1	B2	B3	B4	B5	B6	B7	B8	В9	LEVEL
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	-
	BLUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	-
	GREEN	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	-
BASIC	CYAN	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	-
COLOR	RED	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	-
	MAGENTA	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	-
	YELLOW	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	-
	WHITE	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	-
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R0
		1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R1
	DARK	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R2
GRAY SCALE	I	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	R3~
OF RED	1	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	R1020
	↓ LIGHT	1	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R1021
		0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R1022
	RED	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R1023
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	G0
		0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	G1
CDAY	DARK ↑	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	G2
GRAY SCALE	I	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	••	:	:	:	:	:	:	:	:	:	:	G3~
OF	1	:	•••	:	:	•	:		:	•••	•••	:	:	••	:	:	:	:	:	:	••	:	•••	••	:	:	:	:	•	:	:	G1020
GREEN	↓ LIGHT	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	G1021
		0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	G1022
	GREEN	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	G1023
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	B0
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	B1
GRAY	DARK ↑	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	B2
SCALE	,	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	B3~
OF BLUE	1	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	•	:	:	:	:	:	:	:	:	:	B1020
BLUE	LIGHT	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1		1	1	1	B1021
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	B1022
	BLUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	B1023
,	The definit Rn : Red g			•			en	ara	āν	Bn	; P	Slue	, ui	av	(n	= (	Gra	av I	ev	el)												
	put signal							-	-				-	-	•			-		-1												
		1																														

MODEL	LSF460HN02-A	Doc. No		Page	18 / 42
-------	--------------	---------	--	------	---------

#### 6. Interface timing

#### 6.1 The parameters of timing (Only DE mode)

SIGNAL	ITEM	SMBOL	MIN.	TYP.	MAX.	Unit	NOTE
Clock		1/T <sub>c</sub>	130	148.5	160	MHz	-
Hsync	Frequency	F <sub>H</sub>	48	67.5	75	KHz	-
Vsync		$F_{v}$	48	60	65	Hz	-
Term for the vertical	Active display period	$T_{VD}$	-	1080	-	Lines	-
display	Total vertical	Τ <sub>ν</sub>	1092	1125	1380	Lines	-
Term for the horizontal	Active display period	T <sub>HD</sub>	-	1920	-	Clocks	-
display	Total Horizontal	Т <sub>н</sub>	2090	2200	2350	clocks	-

Note) These products don't have to receive the signal of Hsync & Vsync from the input device.

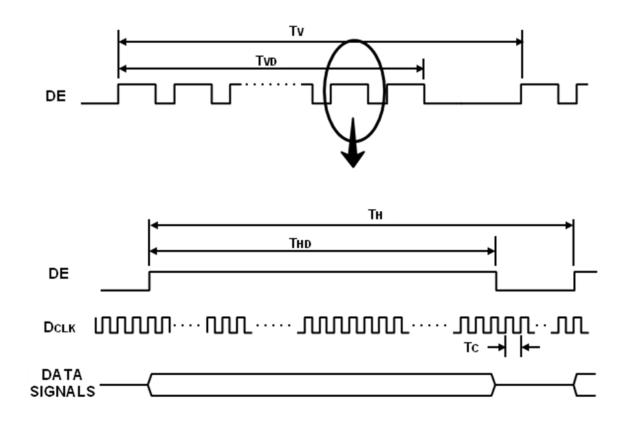
- (1) Key points when testing: TTL controls the signal and the CLK at the input terminal of LVDS Tx of the system.
- (2) Internal VDD = 3.3V
- (3) Spread spectrum
- The limit of spread spectrum's range of SET in which the LCD module is assembled should be within  $\pm$  3 %.

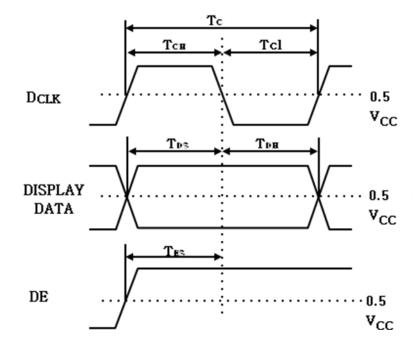
	TxIN/RxOUT28	R0	R8
TxOUT/RxIN4(dithered10bit)	TxIN/RxOUT29	R1	R9
	TxIN/RxOUT30	G0	G8
	TxIN/RxOUT31	G1	G9
	TxIN/RxOUT32	B0	B8
	TxIN/RxOUT33	B1	B9
	TxIN/RxOUT34	RESERVED	RESERVED

MODEL LSF460HN02-A Doc. No Page 19 / 42
---



6.2 Timing diagrams of interface signal (Only DE mode )





MODEL LSF460HN02-A	Doc. No		Page	20 / 42
--------------------	---------	--	------	---------

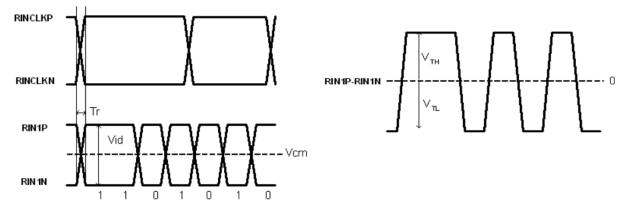


6.3 Characteristics of Input data of LVDS

ITEM	SYMBOL	Min.	Тур.	Max.	UNIT	NOTE	
Differential in threshold v	VTH	-	-	+100	mV	$V_{1} = 1.2V_{1}$	
Differential ir threshold v	•	VTL	-100	-	-	mV	V <sub>CM</sub> = 1.2V
Input common m	V <sub>CM</sub>	0.3	-	1.8	V	-	
Differential Input Voltage		V <sub>ID</sub>	100	350	600	mV	V <sub>ID</sub>  =100mV
Input data position		t <sub>RSRM</sub>	-	-	400	ps	
Input data position	F <sub>IN</sub> =80MHz	t <sub>RSLM</sub>	-400	-		ps	

Notice The spread spectrum should be 0% when the skew is measured.

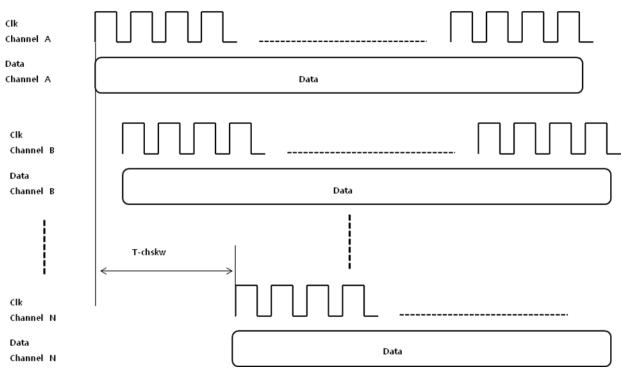
Position of a measurement is T-CON LVDS input pin



MODEL LSF460HN02-A Doc. No Page 21/42	
---------------------------------------	--

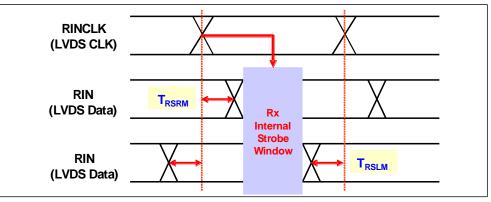


LVDS Channel to Channel Skew (T-chskw) in Multiple LVDS Channels



Note: DE should be synchronized with DE per each LVDS Channel and T-chskw < 16 \* LVDS Clock Period

LVDS Clock to Data Skew (T $_{\mbox{\scriptsize RSRM}}$  & T $_{\mbox{\scriptsize RSLM}}$ ) at each LVDS Channel



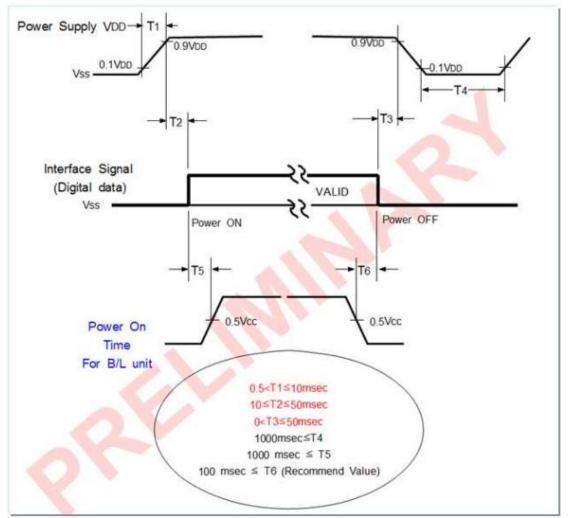
Chara	acteristics	Min.	Тур.	Max.	Unit
	LVDS CLK = 85MHz			400	ps
Input Data Position	LVDS CLK = 78MHz			450	ps
	LVDS CLK = 75MHz			500	ps
	LVDS CLK = 85MHz	400			ps
Input Data Position	LVDS CLK = 78MHz	450			ps
	LVDS CLK = 75MHz	500			ps
	Input Data Position	Input Data Position       LVDS CLK = 78MHz         LVDS CLK = 75MHz         LVDS CLK = 85MHz         Input Data Position         LVDS CLK = 78MHz	Input Data PositionLVDS CLK = 85MHzLVDS CLK = 78MHzLVDS CLK = 75MHzLVDS CLK = 85MHz400LVDS CLK = 78MHzLVDS CLK = 78MHz	Input Data Position         LVDS CLK = 85MHz         Imput Data Position           LVDS CLK = 78MHz         LVDS CLK = 75MHz         Imput Data Position           LVDS CLK = 85MHz         400         Imput Data Position           LVDS CLK = 78MHz         450         Imput Data Position	Input Data Position         LVDS CLK = 85MHz         400           LVDS CLK = 78MHz         450           LVDS CLK = 75MHz         500           LVDS CLK = 85MHz         400           LVDS CLK = 75MHz         500           LVDS CLK = 85MHz         400           LVDS CLK = 75MHz         400

MODEL	LSF460HN02-A	Doc. No		Page	22 / 42
-------	--------------	---------	--	------	---------

## SAMSUNG Confidential

6.4 The sequence of power on and off - Sony Model attached Reference file

To prevent a latch-up phenomena or the DC operation of the LCD Module, the power on/off sequence should be accorded with the settings described in the diagram below.



- T1 : The  $V_{\text{DD}}$  rising time from 10% to 90%
- T2 : The time from the point which  $V_{DD}$  reach to 90% of voltage to the point which the valid data is out\_when the power is on.
- T3: The time from the point which the valid data is out to the point which  $V_{DD}$  reach to the 90% of voltage when the power is off.
- T4: the time from the point which the Vdd decrease to the point which the Vdd increase again for windows to restart.

 $\ensuremath{\mathbbmm}$  The recommended operating condition of the back light system

T5: The time which takes for B/L to be turned on after the signal is entered when the time is on. T6 : The time which takes until the signal is out after BL is turned off

 The condition of supply voltage to enter in the module from the external system should have the same condition as the definition of V<sub>DD</sub>.

• Apply the voltage for the lamp within the range which the LCD operates. when the back light is turned on before the LCD is operated or when the LCD is turned off before the back light is turned off, the display may show the abnormal screen momentarily.

MODEL	LSF460HN02-A	Doc. No		Page	23 / 42
-------	--------------	---------	--	------	---------

## SAMSUNG Confidential

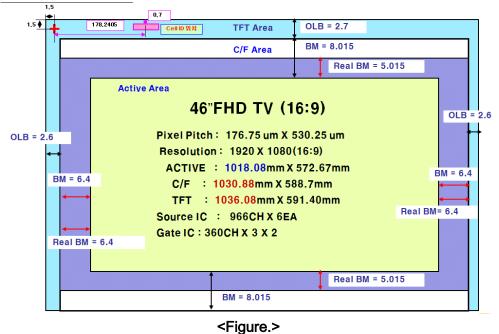
- While the V<sub>DD</sub> is off level, please keep the level of input signals low or keep a high impedance condition.
- The figure of T4 should be measured after the module has been fully discharged between the periods when the power is on and off.
- The interface signal must not keep the high impedance condition when the power is on.

MODEL	LSF460HN02-A	Doc. No	Page	24 / 42
MODEL	LSF460HN02-A	Doc. No	Page	24 / 42

## 7. Outline dimension

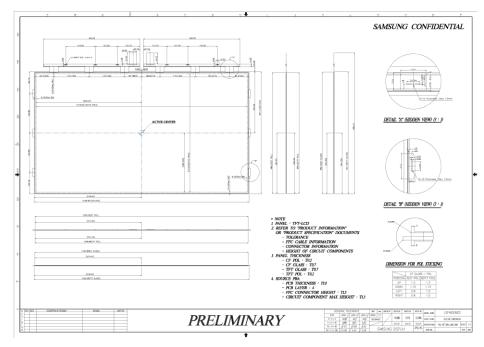
7.1 The adhesive size of POL

The next figure shows the size of POL on the drawing sheet attached to the panel for BLU design.



The POL size of CF : 1029.28 X 586.25  $\pm$  0.2mm The POL size of TFT: 1028.88 X 586.25  $\pm$  0.2mm The total adhesion allowance of POL is  $\pm$ 0.8mm(L/R),  $\pm$ 1.15mm(U/D)

7.2 The drawing sheet for the size of the OLB bonding



MODEL LSF460HN02-A Doc. No Pa	Page	25 / 42
-------------------------------	------	---------



## 8. Reliability test

#### 8.1 Panel

Item		Test Condition	Quantity	Note
HTOL	60 °C (Panel cl	nange 500hr / circuit change 250hr)	8	
LTOL	-5 °C (Panel ch	ange 500hr / circuit change 250hr)	4	
THB	50 ℃ / 90 %RI	H(Panel change 500hr / circuit change 250hr)	10	
	25 °C / Mosaic p	pattern(9*10) 12hrs	0	
Image sticking	Rolling pattern ?	12hrs / 3cycles	- 8	
Decompressio n	-40~50°C, 0m(0	ft) ~ 13,700m(45,000ft), 72.5Hr	4	
HTS	70 °C, Storage	(Panel change 500hr / circuit change 250hr)	4	
LTS	-25 °C, Storage	(Panel change 500hr / circuit change 250hr)	4	
Transportation condition	• • • •	emperature/humidity(-30~60°C / 40°C 90%RH) bration(5~200Hz 1.05Grms, 2hr) → drop(20cm)	1pallet	
WHTS	60 ℃ / 75 %RH , Storage			
Noise	Electromagnetic noise: Overall 23dB 이하			
Complex stress	-20°C~60°C, 0~90%RH, 2cycle			
ESD	S-IC Input ±7KV, Output ±4KV Output 은 data TP 에 직접 인가 후 진행 Input 은 CKV,VCOM 등에 FFC CNT 를 통하여 TEST 를 진행			
EOS (optional)	ItemTest conditionVin Input stepSurge combination (High impedance) Pass Condition: 5kV underSignal Input stepSurge combination (High impedance) Pass Condition: 120V under		2	

#### [Criteria on evaluation]

There should be no change of the product, which may affect to the practical display functions, when the display quality test is executed under the normal operation setting.

- \* HTOL/ LTOL : The operating cycle on the high and low temperature
- \* THB : Temperature humidity slant
- \* HTS/LTS : The storage at the high and low temperature
- \* WHTS : The storage in the high temperature with the high humidity

MODEL LSF460HN02-	Doc. No	Page 26 / 42
-------------------	---------	--------------



## 9. General precautions

- 9.1 Handling
  - (a) When the panel kit and BLU kit are assembled, the panel kit and BLU kit should be attached to the set system firmly by combining each mounted holes. Be careful not to give the mechanical stress.
  - (b) Be careful not to give any extra mechanical stress to the panel when designing the set, and BLU kit.
  - (c) Be cautious not to give any strong mechanical shock and / or any to the panel kit. Applying the any to the panel may cause the abnormal operation or the damage to the panel kit and the back light unit kit.
  - (d) Refrain from applying any to the source PBA and the drive IC in the process of the handling or installing to the set. If any are applied to the products, it may cause damage or a malfunction in the panel kit.
  - (e) Refrain from applying any which cause a constant shock to the back side of panel kit, the set design and BLU kit. If any are applied to the products, it may cause an abnormal display, a functional failure and etc.
  - (f) Note that polarizer could be damaged easily. Do not press or scratch the bare surface with the material which is harder than a HB pencil lead.
  - (g) Wipe off water droplets or oil immediately. If you leave the droplets for a long time on the product, a staining or the discoloration may occur.
  - (h) If the surface of the polarizer is dirty, clean it using the absorbent cotton or the soft cloth.
  - (i) Desirable cleaners are water or IPA (Isopropyl Alcohol).
     Do not use Kenton type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride.
     These might cause the permanent damage to the polarizer due to chemical reaction.
  - (j) If the liquid crystal material leaks from the panel, this should be kept away from the eyes or mouth. If this contacts to hands, legs, or clothes, you must washed it away with soap thoroughly and see a doctor for the medical examination.
  - (k) Protect the panel kit and BLU Kit out of the static electricity. Otherwise the circuit IC could be damaged.

No.	Item	Control standard
1	Ionizer	All Equipment should be controlled under 150V.(Typ. 100V)
2	Carrying Roller	Carrying Roller should be controlled under 200V.
3	Equipment Ground Resistance	All Equipment Ground Should be less than 1ohm.

#### - Reference : Process control standard of SDC



- (I) Remove the stains with finger-stalls wearing soft gloves in order to keep the display clean in the process of the incoming inspection and the assembly process.
- (m) Do not pull or fold the source drive IC which connects to the source PBA and the panel or the gate drive IC.
- (n) Do not pull, fold or bend the source drive IC and the gate drive IC in any processes.
   If not, the source drive IC could be bent one time in the process of assembling the panel Kit and the BLU Kit.
- (o) Do not adjust the variable resistor located on the panel kit and BLU kit except when adjusting the flicker.
- (p) Do not touch the pins of the interface connector directly with bare hands.
- (q) Be cautious not to be peeled off the protection film.

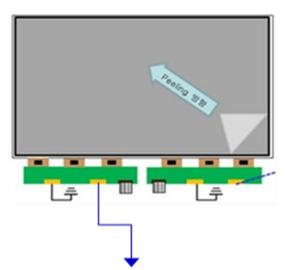


Fig. GND SR-Open Pattern – Be sure to be contacted to the ground while peeling of the protection film

- Make sure to peel off slowly

(It is recommended to peel it off at the speed of more than 8sec. constantly.)

- The peeling direction is shown at the Fig

- Instruct the ground worker to work with the adequate methods such as the antistatic wrist band.

- Maker sure to be grounded the source PBA while peeling of the protection film.

- lonized air should be blown over during the peeling

- The protection film should not t be contacted to the source drive IC.

- If the adhesive stains remain on the polarizer after the protection film is peeled off, please move stains with isopropylalcohol liquid.

- (r) The protection film for the polarizer on the panel kit should be slowly peeled off just before using so that the electrostatic charge can be minimized.
- (s) The panel kit and BLU kit have high frequency circuits. The sufficient suppression to the EMI should be done by the set manufacturers.
- (t) The set of which the panel is assembled shall not be twisted. If the product is twisted, it may cause the damage on the product.
- (u) Surface Temp. of IC should be controlled less than 100°C, operating over the Temp. can cause the damage or decrease of lifetime.

MODEL LSF460HN	02-A Doc. No	Page	28 / 42
----------------	--------------	------	---------



#### 9.2 Storage

The storage condition for packing

ITEM	Unit	Min.	Max.				
Storage Temperature	(°C)	5	40				
Storage Humidity	(%rH)	35	75				
Storage life	Based on sh	12 months Based on shipping date at SDC site					
Storage Condition	Based on shipping date at SDC site           (1) Design the warehouse to be ventilated efficiently with equipping the roof, the ventilation system, and the temp. controller.           (2) Don't load the product on the floor and store the product with loaded on the pallet placed far away from the wall.           (3) Avoid exposing the product to the direct light, moisture, and water and prevent the product from being condensed.           (4) Don't store the product at the container located outside where it rains and the direct light shines.           (5) Prevent the product from being exposed to the noxious gas such as the acid gas or alkali           gas which may damage the electric device.           (6) Don't store the product at the location surrounded by dangerous factors, which can deteriorate the quality of product.						

#### 9.3 Operation

- (a) Do not connect or disconnect the FFC cable during the "Power On" condition.
- (b) Power supply should be always turned on and off by the "Power on/off sequence"
- (c) The module has high frequency circuits. The sufficient suppression to the electromagnetic interference should be done by the system manufacturers. The grounding and shielding methods is important to minimize the interference.
- (d) The cables between TV SET connector and Control PBA interface cable should be connected directly to have a minimized length. A longer cable between TV SET connector and Control PBA interface cable maybe operate abnormal display
- (e) Recommend to age for over 1 hour at least in the state, which the product is driving initially to stabilize the characteristic of the initial TFT.
- (f) Response time depends on the temperature.( In Lower temperature, it becomes longer)

MODEL	LSF460HN02-A	Doc. No		Page	29 / 42
-------	--------------	---------	--	------	---------

- 9.4 Operation condition guide
  - (a) The LCD product shall be operated under normal conditions.

The normal condition is defined as below;

- Temperature : 20±15°C
- Humidity : 55±20%
- Display pattern : continually changing pattern (Not stationary)
- (b) If the product will be used under extreme conditions such as under the high temperature, humidity, display patterns or the operation time etc.., it is strongly recommended to contact SDC for the advice about the application of engineering. Otherwise, its reliability and the function may not be guaranteed. Extreme conditions are commonly found at airports, transit stations, banks, stock markets, and controlling systems.

9.5 Others

- (a) The ultra-violet ray filter is necessary for the outdoor operation.
- (b) Avoid the condensation of water which may result in the improper operation of product or the disconnection of electrode.
- (c) Do not exceed the limit on the absolute maximum rating. (For example, the supply voltage variation, the input voltage variation, the variation in content of parts and environmental temperature, and so on) If not, panel may be damaged.
- (d) If the module keeps displaying the same pattern for a long period of time, the image may be remained to the screen. To avoid the image sticking, it is recommended to use a screen saver.
- (e) This Panel has its circuitry of PCB's on the rear side, so it should be handled carefully in order for a not to be applied.
- (f) Please contact the SDC in advance when the same pattern is displayed for a long time

MODEL	LSF460HN02-A	Doc. No		Page	30 / 42
-------	--------------	---------	--	------	---------



#### SAMSUNG Confidential

## 10. Special precautions

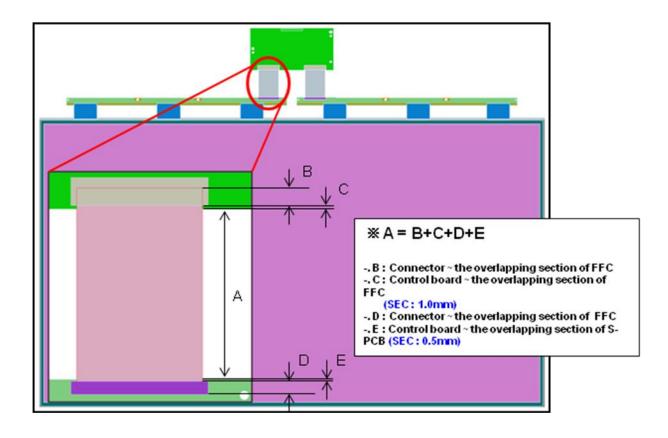
## 10.1 Lists to be cautious when executing the design process

No.	Component	Expected cause			
1	Upholding part for panel	Prevent the panel from breaking by assigning gaps between the panel and the upholding part for panel on the drawing for the upholding part for panel. Refer to the (a), (b), (c) of 3-1 for the design of BLU.			
2	The shape of the upholding part for panel	Design the upholding part for panel to fit to the panel appropriately when designing the BLU since the shape of the upholding part for panel may damage the panel. Refer to the (a), (b), (c) of 3-1 for the design of BLU.			
3	The edge of upholding part for panel	Design the edge of panel to have a sufficient space with the upholding part for panel when designing the BLU since the edge of the upholding part for panel may damage the panel when assembling the panel and BLU. Refer to the (a), (b), (c) of 3-1 for the design of BLU.			
4	Upholding part for panel	Place the upholding part for the panel in order for the shape of mold, which contacts with the panel not to interfere with the area of panel. Refer to the (a), (b), (c) of 3-1 for the design of BLU.			
5	Drive IC	Design the BLU in order for the COF not to contain the lead crack resulted from the tensioned COF created when the product is twisted if the space between the D-IC COF and the middle mold isn't sufficient. Refer to the (a), (b), (c),(d),(e),(f), and (g)of 3-2 for the design of BLU.			
6	Drive IC	Design the BLU in order for the product not to contain the lead crack resulted from the tensioned COF caused under t condition, which the product is twisted by fixing the source PCB. Refer to the (a), (b), (c),(d),(e),(f), and (g)of 3-2 for the design of BLU.			
7	IC component	<ol> <li>The temperature of each part of product suggested by our company and the second vendor shall meet the standard of temperature, which is recommended not to be exceeded by our company when the product is affected under the various temperature ranges.</li> <li>Apply over 1mm long separation distance stated in the safety standard between the electric part and each conductor. (Apply the rated separation distance when insulating.)</li> </ol>			
8	Thermal pad	Apply the thermal pad in a designated size to the product as a measure to lower the temperature of heat in order for each part to use the rated temperature.			
9	POL	The surrounding area of the POL shall be treated with an electrification treatment since the external ESD may cause a phenomenon, which the POL is coming off. In addition, the GND portion of source PBA shall be grounded.			
10	PBA	The GND portion of each PBA shall be contacted with the GND portion of BLU. Refer to the (a) and (b) of 3-3 for the design of BLU.			
11	Circuit	The standardized approval from the client is required since the EMI is executed by a client. Our company can only measure the reference since the client measures the BLU.			
12	The height of component	Design the BLU with considering the maximum height of parts, which our company suggests.			
13	Between the FFC and the C-PBA	Design the instrument with considering the length between the FFC and the control PBA. (The marginal minimum length of 5mm or 8mm is required.)			
14	Panel	The surface temperature of panel shall be maintained within 0°C and 45°C when the external ambient temperature is at 25°C. (Design the BLU with considering the increase of the temperature in the panel by the LED, CCFL, and etc.)			
15	Aging	Recommend to age for over 1 hour at least in the state, which the product is driving initially to stabilize the characteristic of the initial TFT.			
16	The attachment of gasket	The additional confirmation by our company is required If the attachment of gasket to the S-PBA of our company is required.(To fix the S-PBA or the EMI)			
17	Drive IC	Design the top chassis and the driver IC to be contacted by placing the shape of emboss inside the top chassis as a measure to prevent the driver IC from heating. The size of emboss shall be designed in larger size than the size of IC inside the film of the driver IC. Refer to the (a), (b), (c),(d),(e),(f), and (g)of 3-2 for the design of BLU.			
18	The prohibited bandwidth	Design the BLU in order for the BLU not to interfere with the area, where the control PBA and the source PBA are located densely according to the drawing for the BLU from our company.			
19	S-PBA	The material, which contacts with the bottom side of S-PBA which has a pattern shall be non-conducting material or shall be insulated.			

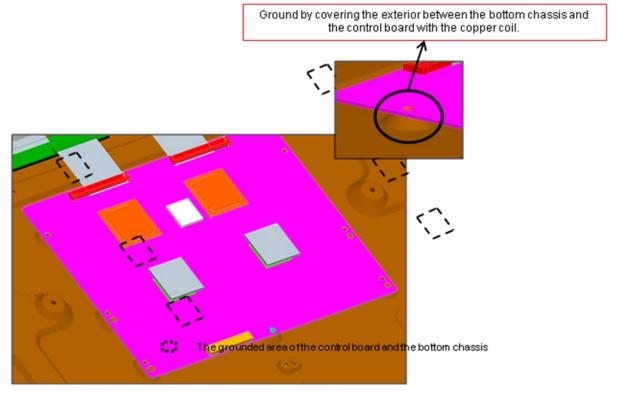
MODEL

## 11. Example

. The length between the FFC and the C-PBA



. The grounding of PCB



MODEL	LSF460HN02-A	Doc. No		Page	32 / 42
-------	--------------	---------	--	------	---------



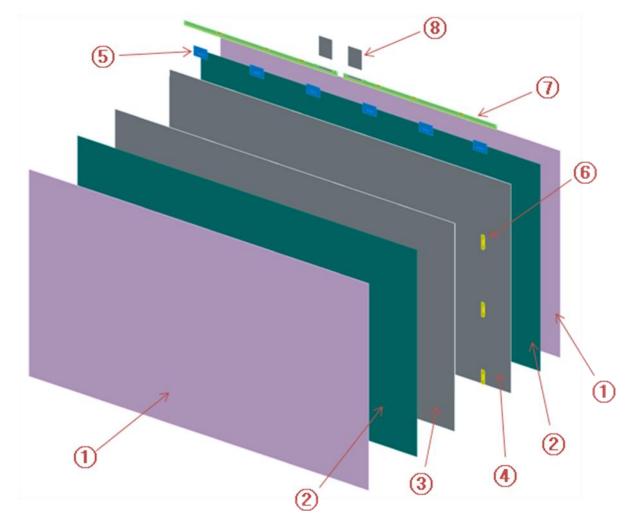
Appendix Recommendation for the BLU Design

The Information described in this specification is for the first draft and can be changed without prior notice

# Samsung Display Co., LTD

MODEL	LSF460HN02-A	Doc. No		Page	33 / 42
-------	--------------	---------	--	------	---------

1. The schematic of panel



Item	Symbol	Remark
Protector Film	1	Removable
Polaroid Film	2	
Color Filter Glass	3	
TFT Glass	4	
Source IC	6	
Gate IC	6	
Source PBA	Ø	
FFC	8	

MODEL	LSF460HN02-A	Doc. No		Page	34 / 42
-------	--------------	---------	--	------	---------

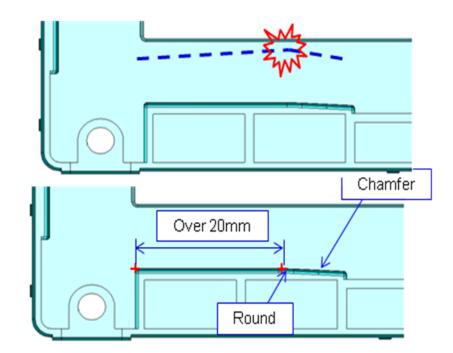
## 3. The guide for the mechanical design

- 3.1 The panel guide
  - (a) It is recommended to avoid the following cases since the light leakage can be caused by the pressure of the guiding structure.

When the guiding part is made of plastic resin, the gap between the panel and the guiding structure should be considered when you design. The shrinkage under the situation which the temperatures change causes the light leakage. For your reference, it is recommended to have a total gap between the panel and the guide structure as below (When the resin is composed of the PC and the 15% of G/F.)

	<b>⊡</b> † <b>%</b>	32"	40"	46"	55"
Total Gap	Right & Left	0.9	0.9	1.0	1.1
	Top & Bottom	0.6	0.7	0.8	0.9

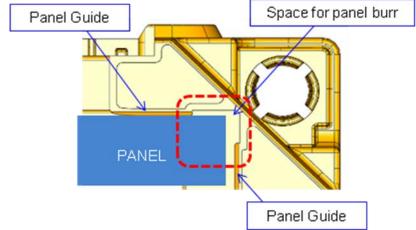
It is recommended to follow the dimension and the shape of the guiding structure stated as below since the distortion of guiding parts can cause the light leakage



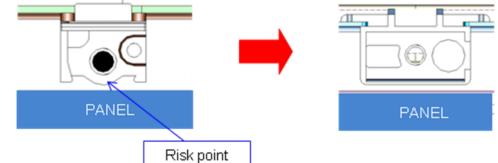
MODEL	LSF460HN02-A	Doc. No		Page	35 / 42
-------	--------------	---------	--	------	---------

## SAMSUNG Confidential

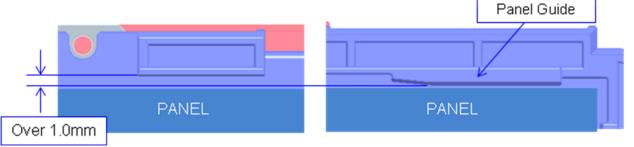
(b) When the panel guide point is designed at the edge of the panel, the points in the corner shall not be designed to be contacted with the other parts in order to avoid the crack on the panel caused by the burr of the panel.



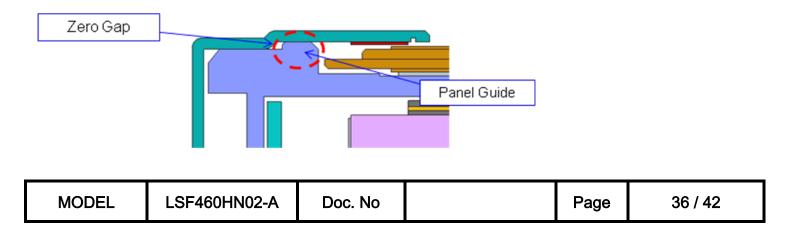
- (c) It is recommended to avoid placing the ribs as shown below since the panel damage with the unstable design can be easily happened under the external
  - -. The or the round shape near the panel shall be changed to a flat shape, such as the shape of screw point, the date point. and etc.



- -. It is recommended to keep the gap between the panel guides and ribs over 1mm in the worst conditions.
  - (X The suggested dimension does not guarantee the quality of the products.)

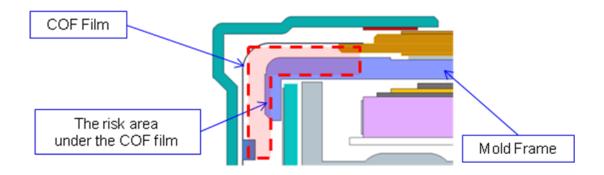


-. The gap between the panel guide and the front cover (or the front chassis) should be a zero in Zdirection to avoid the being broken in the panel caused by being stuck between the gap.

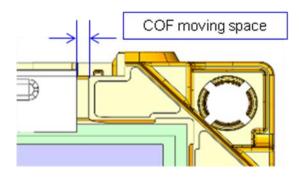


#### 3.2 The COF and the Drive IC

(a) The pattern of COF is easily damaged by the edge of the press and the burr of mold under the condition which the products are shaking while delivering. Therefore, it is recommended to avoid designing not to locate the gate of mold or the parting line in the position of COF when designing the product.



(b) It is recommended to secure the sufficient gap between the COF and the other parts when designing the product since the lack of gap between the COF and the other parts can cause the damage in the COF such as the lead crack under the condition which the product is twisted.
(X The space over 3.0mm for moving is recommended, but the quality of products is not guaranteed.)



(c) The temperature of the surface of Drive-IC should be less than 100°C

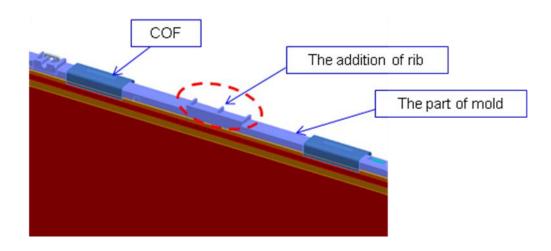
MODEL	LSF460HN02-A	Doc. No		Page	37 / 42
-------	--------------	---------	--	------	---------

#### SAMSUNG Confidential

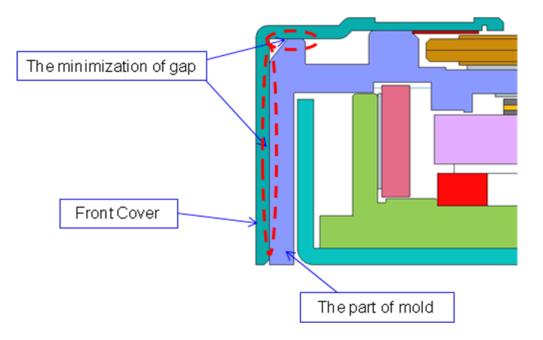
#### SAMSUNG SAMSUNG DISPLAY

(d) The sufficient space for the COF and the Drive IC should be prepared including the worst condition to prevent the damage on Drive-IC from the external

-. If the panel is placed to the upper part of the mold, it is recommended to keep the gap between the mold and the front cover or the mold and the top chassis by adding the rib between the COF and COF.



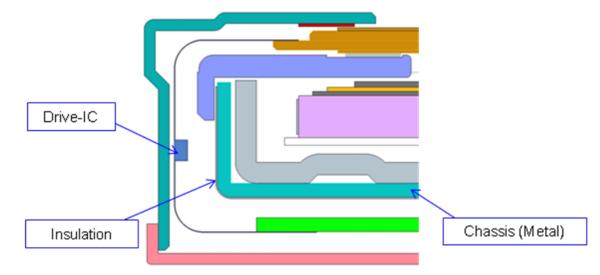
-. Design the gap between the rib and the cover to maintain the space for the protection of COF as small as possible



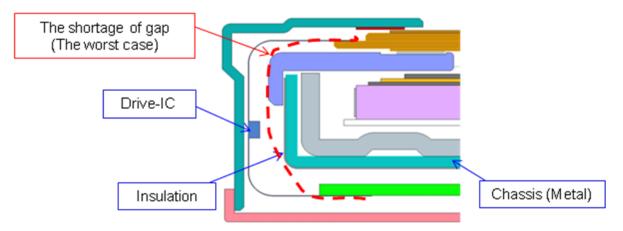


## SAMSUNG Confidential

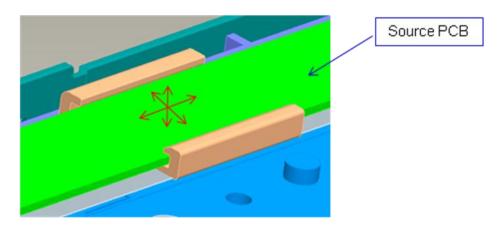
(e) When metal parts are assembled next to the Drive-IC, the metal part should be insulated to avoid the damage on IC from the static electricity.



(f) If the length of COF is designed to be short, the lead crack can be occurred by applying the tension on the COF due to the being shaking of the product.



(g) It is recommended to design source PCB can be easily moved to the direction of each axis in order for the tension not to be applied to the edge of COF under vibrating condition, such as transportation of the product.

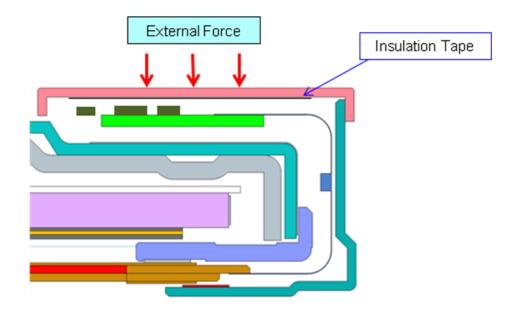


MODEL LSF460HN02-A Doc. No Page 39 / 42	2
---	---

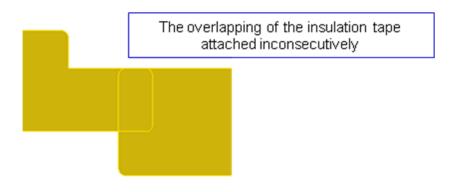
#### SAMSUNG Confidential

#### 3.3 The control PBA and the Source PBA

(a) The gaps between the source PBA and the other parts and the control PBA and other parts should be considered to avoid the damage on electrical parts by the static electricity and the external If the material of shielding part is metal, the insulation method is recommended.



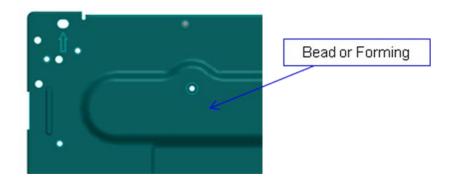
(b) Confirm the status of insulation tape since the inappropriately attached insulation tape can cause the damage on the parts of product if the insulation tape for the insulation of part of PBA is attached inconsecutively due to the inappropriate design or the error occurred during the process.



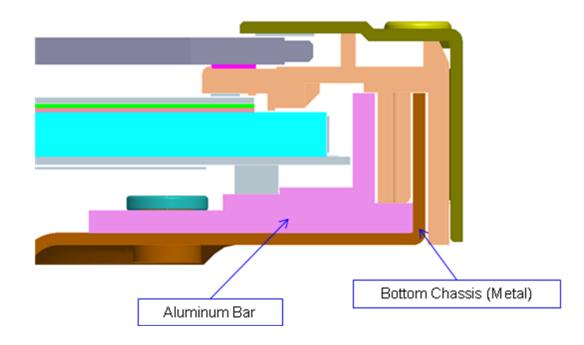
MODEL	LSF460HN02-A	Doc. No	Page	40 / 42

## 3. 4 The 4-Corner and the cloudy light leakage

- (a) It is recommended to follow the method delineated in the picture below for designing since the distortion on panel and the increase of the temperature gradient in the surface of panel can cause the light leakage.
  - -. Place the strong beads at the corner point to control the flatness of the panel.



-. The heat sinking plane in the lower parts shall contact with the bottom chassis.

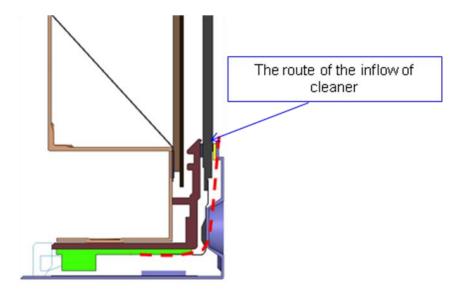


MODEL	LSF460HN02-A	Doc. No		Page	41 / 42
-------	--------------	---------	--	------	---------

#### 3.5 Others

(a) The corrosion of the source PBA

Be cautious when selecting the specification of tape or designing the product since the corrosion of the parts of circuit caused by the overuse of the glass cleaner of the end user may cause the occurrence of the abnormalities in the screen, if the model is the reversed product which has the source PBA designed at the 90°.



(b) The deterioration of crystal liquid

It is recommended to design the products to make the temperature of the active area of the product operated below the 50°C for the protection from containing the abnormalities in the screen due to the deterioration of the liquid crystal. In addition, it is recommended to design the product not to cause the occurrence of the deterioration of liquid crystal under the ambient temperature of 50 °C.

MODEL	LSF460HN02-A	Doc. No		Page	42 / 42
-------	--------------	---------	--	------	---------